

HSF

NOTES:

Current Rating: 1.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 500V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
Contact plating: Au over Ni
Insulator Material: PA9T+30%GF UL94V-0

Ordering Information

2446-2 XX S XX CYN T X

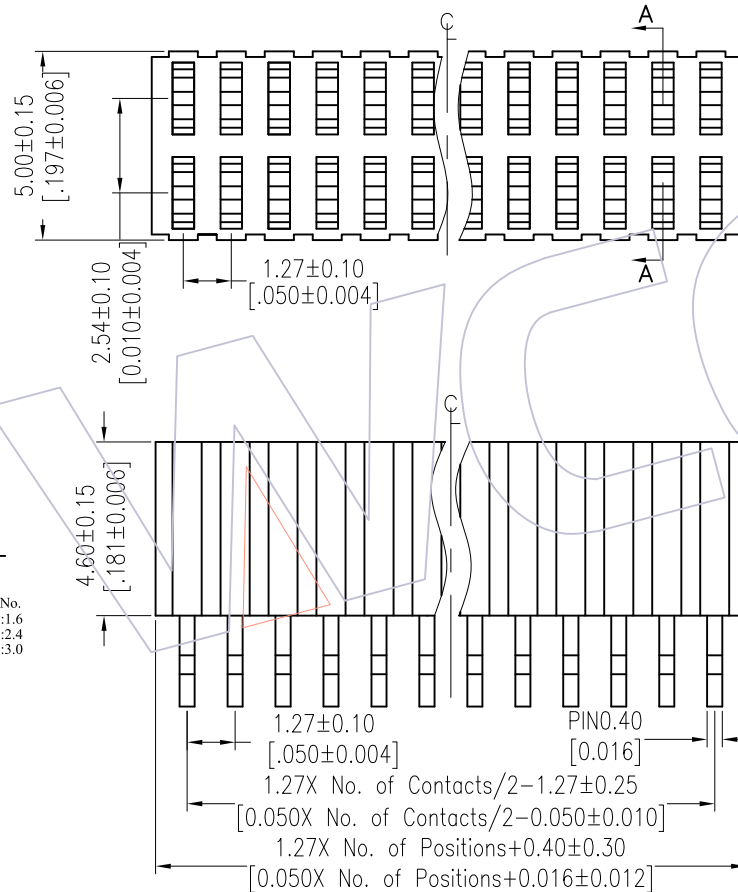
No. of Pins per
Row: 02-50Pin

Contact Plating:
G0=Gold Flash
G3=10μ"Gold
G4=15μ"Gold
G5=30μ"Gold

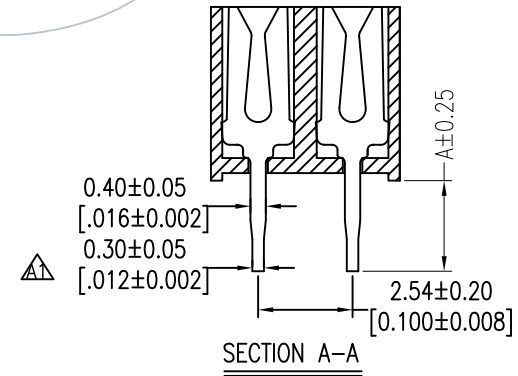
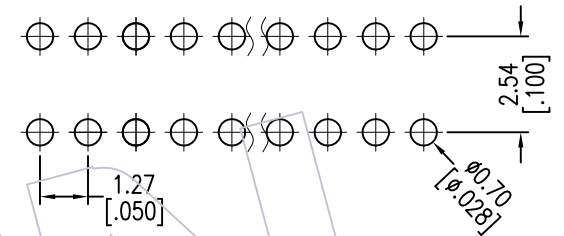
Packing:
T=Tube

Series No.
1=DIP:1.6
2=DIP:2.4
3=DIP:3.0

Item	Pitch	Mating
Standard	1.27	1417/1425
Alternate		



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



DIM	PART NO.
A=1.6	2446-2XXSXXCYNT1
A=2.4	2446-2XXSXXCYNT2
A=3.0	2446-2XXSXXCYNT3

			OPERATION		DRAW Wang	DATE 2013/11/11	SCALE UNIT	FIT mm	PART NO. SEE TABLE
A1	2013/11/11	ADD DIM:0.30	X.X	±0.40					
A0	2012/07/10	NEW	X.XX	±0.25	CHECK	DATE	SIZE	A4	TITLE: FH1.27x2.54mm DUAL Row 180° DIP H=4.60
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	Angle DIM	± 3° TOL	APPROVE	DATE	SHEET 1/1	Customer NO.